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Vishay Semiconductors

# INT-A-PAK<sup>™</sup> "Half-Bridge" (Ultrafast Speed IGBT), 100 A



PRODUCT SUMMARY			
V <sub>CES</sub>	1200 V		
I <sub>C</sub> DC	182 A		
V <sub>CE(on)</sub> at 100 A, 25 °C	2.25 V		

### FEATURES

- Generation 4 IGBT technology
- Ultrafast: Optimized for high speed 8 kHz to 40 kHz in hard switching, > 200 kHz in resonant mode



COMPLIANT

- Very low conduction and switching losses
- HEXFRED<sup>®</sup> antiparallel diodes with ultrasoft recovery
- Industry standard package
- UL approved file E78996
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### BENEFITS

- Increased operating efficiency
- Direct mounting to heatsink
- Performance optimized for power conversion: UPS, SMPS, welding
- Lower EMI, requires less snubbing

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL TEST CONDITIONS		MAX.	UNITS	
Collector to emitter voltage	V <sub>CES</sub>		1200	V	
	1	T <sub>C</sub> = 25 °C	182		
Continuous collector current	I <sub>C</sub>	T <sub>C</sub> = 93 °C	100		
Pulsed collector current	I <sub>CM</sub>	Repetitive rating; $V_{GE} = 20$ V, pulse width limited by maximum junction temperature	200	А	
Peak switching current See fig. 17	I <sub>LM</sub>		200		
Peak diode forward current	I <sub>FM</sub>		200		
Gate to emitter voltage	V <sub>GE</sub>		± 20	v	
RMS isolation voltage	V <sub>ISOL</sub>	Any terminal to case, t = 1 minute	2500	V	
Maximum power dissipation	P <sub>D</sub>	T <sub>C</sub> = 25 °C	520	w	
		T <sub>C</sub> = 85 °C	270	vv	
Operating junction temperature range	TJ		- 40 to + 150	°C	
Storage temperature range	T <sub>Stg</sub>		- 40 to + 125	50	



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<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V <sub>(BR)CES</sub>	$V_{GE} = 0 V, I_{C} = 1 mA$	1200	-	-		
	V <sub>CE(on)</sub>	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 100 \text{ A}$	-	2.25	3	v	
Collector to emitter voltage		$V_{GE}$ = 15 V, $I_{C}$ = 100 A, $T_{J}$ = 125 °C	-	2	2.4	v	
Gate threshold voltage	V <sub>GE(th)</sub>	I <sub>C</sub> = 1.25 mA	3.0	4.4	6.0		
Temperature coefficient of threshold voltage	$\Delta V_{GE(th)} / \Delta T_J$	$V_{CE} = V_{GE}$ , $I_C = 1.25 \text{ mA}$	-	- 12	-	mV/°C	
Forward transconductance	9fe	V <sub>CE</sub> = 25 V, I <sub>C</sub> = 100 A Pulse width 50 µs, single shot	-	136	-	S	
Collector to emitter leaking current	I <sub>CES</sub>	$V_{GE} = 0 \text{ V}, V_{CE} = 1200 \text{ V}$	-	0.03	1.0		
		$V_{GE} = 0 \text{ V}, \text{ V}_{CE} = 1200 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	4.2	10	mA	
Maximum diode forward voltage	V <sub>FM</sub>	V <sub>GE</sub> = 0 V, I <sub>F</sub> = 100 A	-	3.3	4.0	v	
		$V_{GE} = 0 \text{ V}, I_F = 100 \text{ A}, T_J = 125 ^\circ\text{C}$	-	3.2	3.8	v	
Gate to emitter leakage current	I <sub>GES</sub>	$V_{GE} = \pm 20 \text{ V}$	-	-	250	nA	

SWITCHING CHARACTERISTICS	<b>S</b> (T <sub>J</sub> = 25 °C	Cunless otherwise noted)				
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Qg		-	830	1245	nC
Gate to emitter charge (turn-on)	Q <sub>ge</sub>	$V_{CC} = 400 V$ $I_{C} = 124 A$	-	140	210	
Gate to collector charge (turn-on)	Q <sub>gc</sub>		-	275	412	
Turn-on delay time	t <sub>d(on)</sub>		-	570	-	-
Rise time	t <sub>r</sub>	$R_{g1} = 15 \Omega$	-	85	-	
Turn-off delay time	t <sub>d(off)</sub>	$R_{g2} = 0 \Omega$	-	581	-	ns
Fall time	t <sub>f</sub>	I <sub>C</sub> = 100 A V <sub>CC</sub> = 720 V	-	276	-	
Turn-on switching energy	Eon	$V_{GE} = \pm 15 \text{ V}$	-	7.6	-	mJ
Turn-off switching energy	E <sub>off</sub> <sup>(1)</sup>	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	-	6.8	-	
Total switching energy	E <sub>ts</sub> <sup>(1)</sup>		-	14.4	-	
Turn-on delay time	t <sub>d(on)</sub>		-	571	-	- ns
Rise time	t <sub>r</sub>	$R_{g1} = 15 \Omega$	-	89	-	
Turn-off delay time	t <sub>d(off)</sub>	$R_{g2} = 0 \Omega$	-	606	-	
Fall time	t <sub>f</sub>	I <sub>C</sub> = 100 A V <sub>CC</sub> = 720 V	-	649	-	
Turn-on switching energy	Eon	V <sub>GE</sub> = ± 15 V T <sub>J</sub> = 125 °C	-	10	-	mJ
Turn-off switching energy	E <sub>off</sub> <sup>(1)</sup>		-	16	-	
Total switching energy	E <sub>ts</sub> <sup>(1)</sup>		-	26	45	
Input capacitance	Cies	V <sub>GE</sub> = 0 V	-	18 672	-	
Output capacitance	C <sub>oes</sub>	$V_{CC} = 30 V$	-	830	-	pF
Reverse transfer capacitance	C <sub>res</sub>	f = 1 MHz	-	161	-	1
Diode reverse recovery time	t <sub>rr</sub>	$I_{C} = 100 \text{ A}$ $R_{g1} = 15 \Omega$	-	149	-	ns
Diode peak reverse current	l <sub>rr</sub>		-	104	-	Α
Diode recovery charge	Q <sub>rr</sub>	$R_{g2} = 0 \Omega$ $V_{CC} = 720 V$	-	7664	-	nC
Diode peak rate of fall of recovery during $t_b$	dl <sub>(rec)M</sub> /dt	dl/dt = 1300 A/µs	-	1916	-	A∕µs

Note

 $^{(1)}$  Repetitive rating; V<sub>GE</sub> = 20 V, pulse width limited by maximum junction temperature

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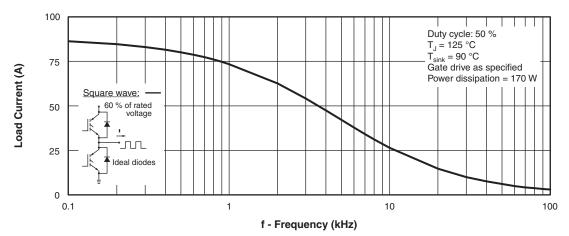
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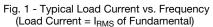
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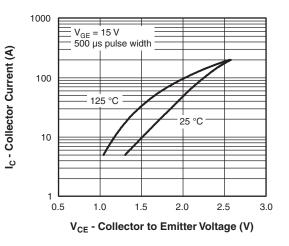


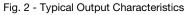
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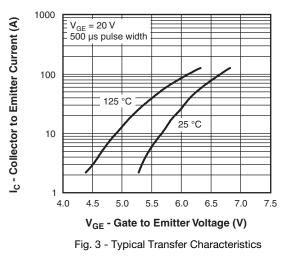
THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	TYP.	MAX.	UNITS
Thormal registeres	IGB1			-	0.24	°C/W
Thermal resistance,	Diode	R <sub>thJC</sub>		-	0.35	
Thermal resistance, case to sink per module		R <sub>thCS</sub>		0.1	-	
Mounting torque case to to	case to heatsin	ζ		-	4.0	Nm
	case to terminal 1, 2 and 3	3	For screws M5 x 0.8	-	3.0	INITI
Weight of module				200	-	g











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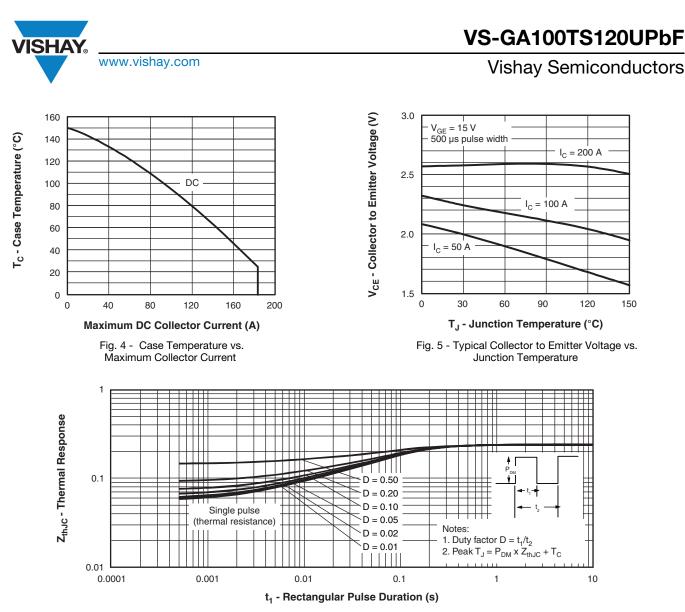
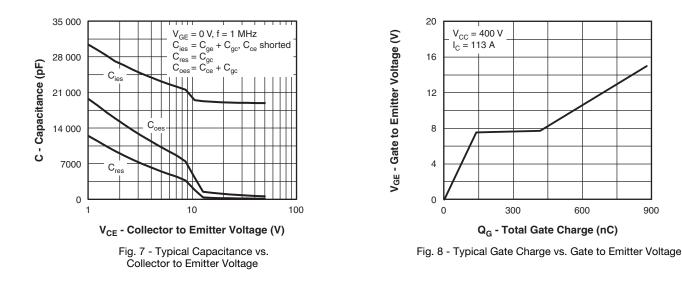


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction to Case



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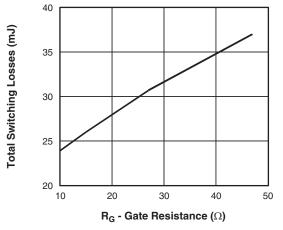


Fig. 9 - Typical Switching Losses vs. Gate Resistance

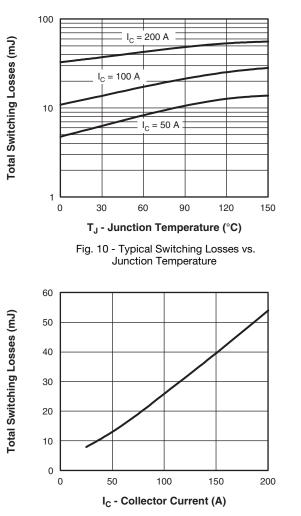


Fig. 11 - Typical Switching Losses vs. Collector Current

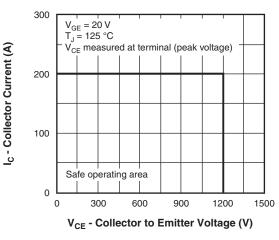


Fig. 12 - Reverse Bias SOA

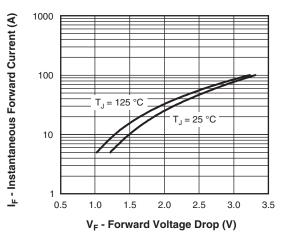


Fig. 13 - Typical Forward Voltage Drop vs. Instantaneous Forward Current

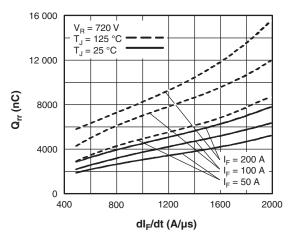


Fig. 14 - Typical Stored Charge vs. dl<sub>F</sub>/dt

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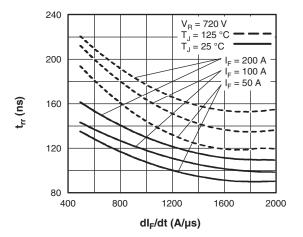


Fig. 15 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

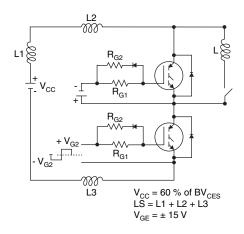
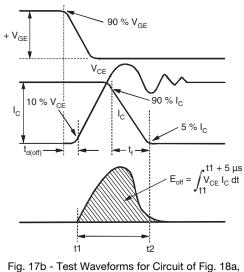
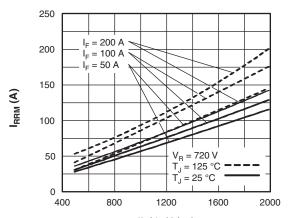


Fig. 17a - Test Circuit for Measurement of I<sub>LM</sub>, E<sub>on</sub>, E<sub>off(diode)</sub>, t<sub>rr</sub>, Q<sub>rr</sub>, I<sub>rr</sub>, t<sub>d(on)</sub>, t<sub>r</sub>, t<sub>d(off)</sub>, t<sub>f</sub>



Defining Eoff, td(off), tf



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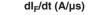


Fig. 16 - Typical Recovery Current vs. dl<sub>F</sub>/dt

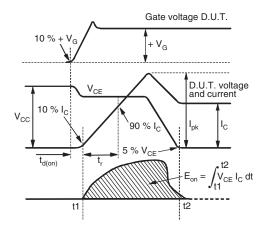


Fig. 17c - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{on}$ ,  $t_{d(on)}$ ,  $t_r$ 

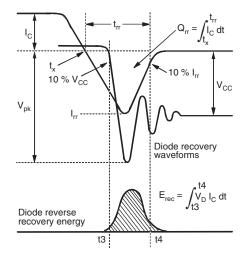


Fig. 17d - Test Waveforms for Circuit of Fig. 18a, Defining E<sub>rec</sub>, t<sub>rr</sub>, Q<sub>rr</sub>, I<sub>rr</sub>

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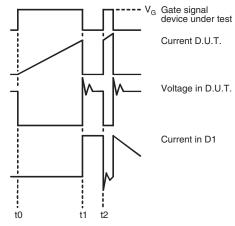
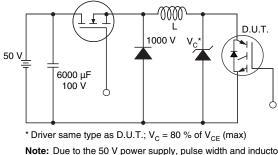
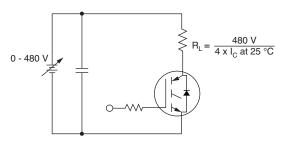


Fig. 17e - Macro Waveforms for Figure 18a's Test Circuit



Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain rated  $\rm I_d$ 

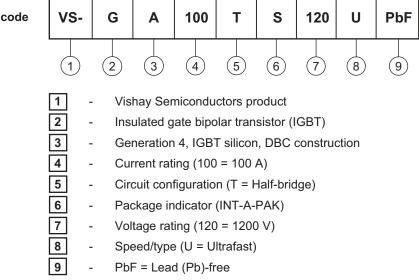
Fig. 18 - Clamped Inductive Load Test Circuit





### **ORDERING INFORMATION TABLE**

Device code



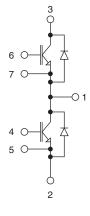
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### **CIRCUIT CONFIGURATION**



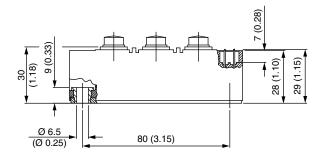
LINKS TO RELATED DOCUMENTS			
Dimensions	www.vishay.com/doc?95173		

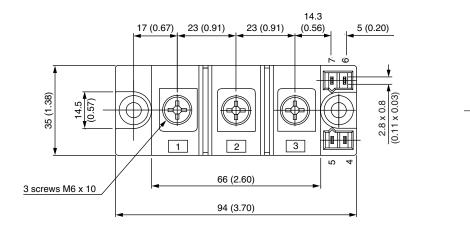
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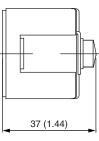


## **INT-A-PAK IGBT**

### **DIMENSIONS** in millimeters (inches)









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